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### Jameco Part Number 2011918

# MMBZ15VDLT1, MMBZ27VCLT1

**Preferred Devices** 

# 40 Watt Peak Power Zener Transient Voltage Suppressors

## SOT-23 Dual Common Cathode Zeners for ESD Protection

These dual monolithic silicon zener diodes are designed for applications requiring transient overvoltage protection capability. They are intended for use in voltage and ESD sensitive equipment such as computers, printers, business machines, communication systems, medical equipment and other applications. Their dual junction common cathode design protects two separate lines using only one package. These devices are ideal for situations where board space is at a premium.

The MMBZ27VCLT1 can be used to protect a single wire communication network form EMI and ESD transient surge voltages. The MMBZ27VCLT1 is recommended by the Society of Automotive Engineers (SAE), February 2000, J2411 "Single Wire Can Network for Vehicle Applications" specification as a solution for transient voltage problems.

#### **Specification Features:**

- SOT-23 Package Allows Either Two Separate Unidirectional Configurations or a Single Bidirectional Configuration
- Working Peak Reverse Voltage Range 12.8 V, 22 V
- Standard Zener Breakdown Voltage Range 15 V, 27 V
- Peak Power 40 W @ 1.0 ms (Bidirectional), per Figure 5 Waveform
- ESD Rating of Class N (exceeding 16 kV) per the Human Body Model
- Low Leakage < 100 nA
- Flammability Rating: UL 94 V-O
- Pb-Free Packages are Available

#### **Mechanical Characteristics:**

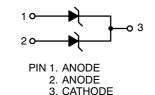
CASE: Void-free, transfer-molded, thermosetting plastic case FINISH: Corrosion resistant finish, easily solderable MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:

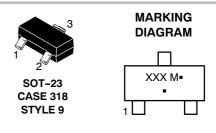
260°C for 10 Seconds



## **ON Semiconductor®**

http://onsemi.com







(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MMBZ15VDLT1	SOT-23	3000/Tape & Reel
MMBZ15VDLT1G	SOT-23 (Pb-Free)	3000/Tape & Reel
MMBZ15VDLT3	SOT-23	10,000/Tape & Reel
MMBZ15VDLT3G	SOT-23 (Pb-Free)	10,000/Tape & Reel
MMBZ27VCLT1	SOT-23	3000/Tape & Reel
MMBZ27VCLT1G	SOT-23 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

**Preferred** devices are recommended choices for future use and best overall value.

## MMBZ15VDLT1, MMBZ27VCLT1

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Power Dissipation @ 1.0 ms (Note 1) @ $T_L \le 25^{\circ}C$	P <sub>pk</sub>	40	Watts
Total Power Dissipation on FR-5 Board (Note 2) @ T <sub>A</sub> = 25°C Derate above 25°C	PD	225 1.8	mW mW/°C
Thermal Resistance Junction-to-Ambient	$R_{\thetaJA}$	556	°C/W
Total Power Dissipation on Alumina Substrate (Note 3) @ T <sub>A</sub> = 25°C Derate above 25°C	PD	300 2.4	mW mW/°C
Thermal Resistance Junction-to-Ambient	$R_{\thetaJA}$	417	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to +150	°C
Lead Solder Temperature - Maximum (10 Second Duration)	TL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Nonrepetitive current pulse per Figure 5 and derate above  $T_A = 25^{\circ}C$  per Figure 6.

2. FR-5 = 1.0 x 0.75 x 0.62 in.

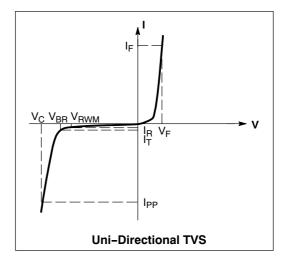
3. Alumina = 0.4 x 0.3 x 0.024 in., 99.5% alumina

#### **ELECTRICAL CHARACTERISTICS**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

**UNIDIRECTIONAL** (Circuit tied to Pins 1 and 3 or 2 and 3)

Symbol	Parameter
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current
V <sub>C</sub>	Clamping Voltage @ IPP
V <sub>RWM</sub>	Working Peak Reverse Voltage
I <sub>R</sub>	Maximum Reverse Leakage Current @ V <sub>RWM</sub>
V <sub>BR</sub>	Breakdown Voltage @ I <sub>T</sub>
Ι <sub>Τ</sub>	Test Current
V <sub>BR</sub>	Maximum Temperature Coefficient of $V_{BR}$
١ <sub>F</sub>	Forward Current
V <sub>F</sub>	Forward Voltage @ I <sub>F</sub>



### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

UNIDIRECTIONAL (Circuit tied to Pins 1 and 3 or Pins 2 and 3)

 $(V_F = 0.9 V Max @ I_F = 10 mA)$ 

				Breakdown Voltage			V <sub>C</sub> @ I <sub>PF</sub>	o (Note 5)		
	Device	V <sub>RWM</sub>	I <sub>R</sub> @ V <sub>RWM</sub>	V <sub>BR</sub> (Note 4) (V)		@ I <sub>T</sub>	v <sub>c</sub>	I <sub>PP</sub>	V <sub>BR</sub>	
Device	Marking	Volts	nA	Min	Nom	Max	mA	v	Α	mV/°C
MMBZ15VDLT1, G*	15D	12.8	100	14.3	15	15.8	1.0	21.2	1.9	12

(V<sub>F</sub> = 1.1 V Max @ I<sub>F</sub> = 200 mA)

				Breakdown Voltage			V <sub>C</sub> @ I <sub>PF</sub>	o (Note 5)		
	Device	V <sub>RWM</sub>	I <sub>R</sub> @ V <sub>RWM</sub>	VBI	V <sub>BR</sub> (Note 4) (V) @		@ I <sub>T</sub>	Vc	I <sub>PP</sub>	V <sub>BR</sub>
Device	Marking	Volts	nA	Min	Nom	Max	mA	v	Α	mV/°C
MMBZ27VCLT1, G*	27C	22	50	25.65	27	28.35	1.0	38	1.0	26

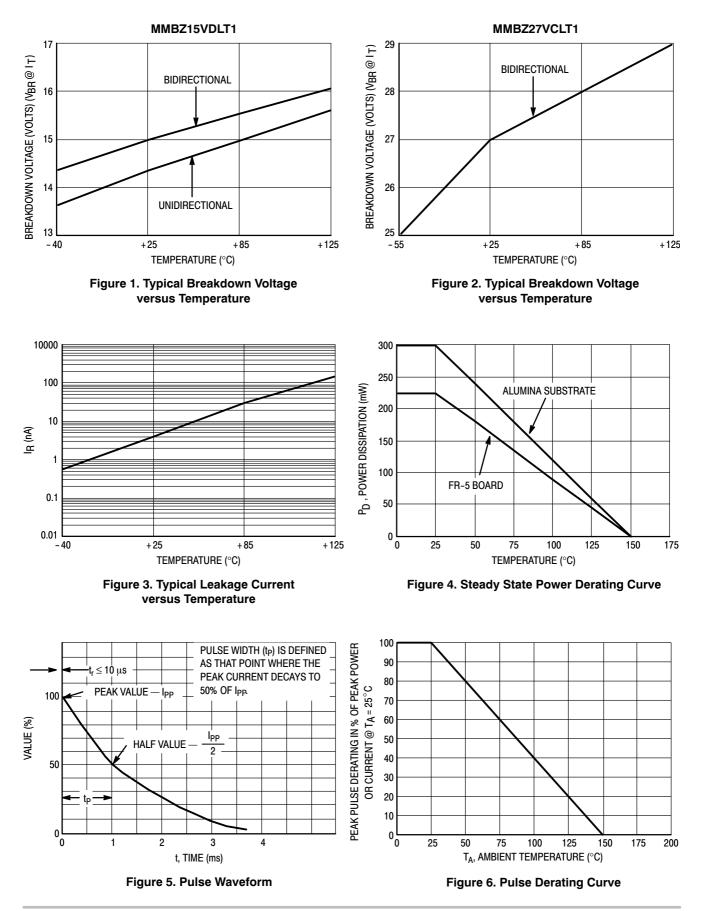
\*The "G" suffix indicates Pb-Free package available.

4. V<sub>BR</sub> measured at pulse test current I<sub>T</sub> at an ambient temperature of 25°C.

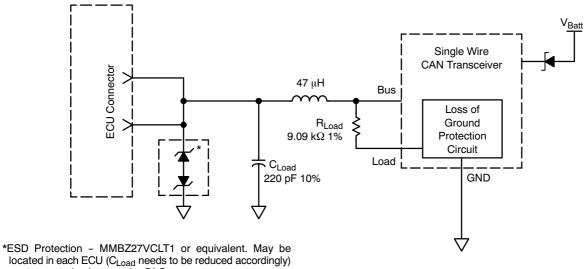
5. Surge current waveform per Figure 5 and derate per Figure 6

## MMBZ15VDLT1, MMBZ27VCLT1

## **TYPICAL CHARACTERISTICS**



## **TYPICAL APPLICATIONS**



or at a central point near the DLC.

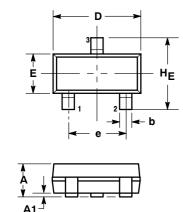
Figure 7. Single Wire CAN Network

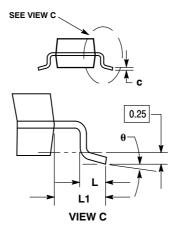
Figure is the recommended solution for transient EMI/ESD protection. This circuit is shown in the Society of Automotive Engineers February, 2000 J2411 "Single Wire CAN Network for Vehicle Applications" specification (Figure 6, page 11). Note: the dual common anode zener configuration shown above is electrically equivalent to a dual common cathode zener configuration.

### MMBZ15VDLT1, MMBZ27VCLT1

#### PACKAGE DIMENSIONS

#### SOT-23 (TO-236) CASE 318-08 ISSUE AN





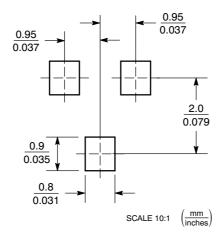
NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF
- BASE MATERIAL. 4. 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08.

	м	ILLIMETE	RS	INCHES				
DIM	MIN NOM MAX		MIN	NOM	MAX			
Α	0.89	1.00	1.11	0.035	0.040	0.044		
A1	0.01	0.06	0.10	0.001	0.002	0.004		
b	0.37	0.44	0.50	0.015	0.018	0.020		
С	0.09	0.13	0.18	0.003	0.005	0.007		
D	2.80	2.90	3.04	0.110	0.114	0.120		
E	1.20	1.30	1.40	0.047	0.051	0.055		
е	1.78	1.90	2.04	0.070	0.075	0.081		
L	0.10	0.20	0.30	0.004	0.008	0.012		
L1	0.35	0.54	0.69	0.014	0.021	0.029		
HE	2.10	2.40	2.64	0.083	0.094	0.104		

STYLE 9: PIN 1. ANODE 2. ANODE 3. CATHODE

#### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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